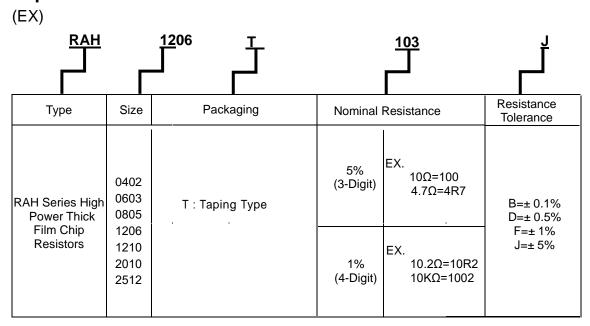


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1 Scope:

- 1.1 This specification is applicable to lead free and halogen free of ROHS directive for RAH series high power thick film chip resistors.
- 1.2 This product is for automotive electronic application.
- 1.3 AEC-Q200 qualified, grade 0.

2 Explanation Of Part Number:



3 General Specifications:

	Rated	Max.	Max.	TCD		Resista	nce Range	
Туре	Power At 70℃	Working Voltage	Overload Voltage	T.C.R (ppm/℃)	B(±0.1%) E-24、E-96	D(±0.5%) E-24、E-96	F(±1%) E-24、E-96	J(±5%) E-24
RAH	W	75V	100V	±100	$100\Omega \! \leq \! R \! \leq \! 1M\Omega$	$10\Omega\!\leqq\!R\!<\!1M\Omega$	10Ω \leq R $<$ $10M\Omega$	10Ω≦R<20MΩ
(0402)	10	750	100 V	±200		1Ω≦R<10Ω	$1\Omega \le R < 10\Omega$	1Ω≦R<10Ω
RAH	W	75\/	150\/	±150	$100\Omega \le R \le 1M\Omega$	$10\Omega\!\leqq\!R\!<\!1M\Omega$	$10\Omega \le R < 10M\Omega$	10Ω≦R<20MΩ
(0603)	4 VV	75V	150V	±200			$1\Omega \le R < 10\Omega$	1Ω≦R<10Ω
RAH	2	450\/	2001/	±100	$100\Omega \le R \le 1M\Omega$	10Ω≦R<1MΩ	10Ω≦R<10MΩ	10Ω≦R<20MΩ
(0805)	RAH (0805) 2 W 150V	1500	300V	±200			1Ω≦R<10Ω	1Ω≦R<10Ω
RAH	1 ,,,	2001/	400)/	±100	10Ω≦R≦1MΩ	10Ω≦R<1MΩ	10Ω≦R<10MΩ	10Ω≦R<20MΩ
(1206)	 W	200V	400V	±200	3Ω≦R<10Ω		1Ω≦R<10Ω	1Ω≦R<10Ω
RAH	3 ,,,	2001/	400)/	±100	$100\Omega \le R \le 1M\Omega$	$10\Omega \le R < 1M\Omega$	10Ω≦R<10MΩ	10Ω≦R<20MΩ
(1210)		200V	400V	±200			1Ω≦R<10Ω	1Ω≦R<10Ω
RAH	410/	2001/	400)/	±100	$100\Omega \le R \le 1M\Omega$	10Ω≦R<1MΩ	10Ω≦R<10MΩ	10Ω≦R<10MΩ
(2010)	1W	200V	0V 400V	±200			1Ω≦R<10Ω	1Ω≦R<10Ω
RAH	2W	2001/	400\/	±100	$100\Omega \le R \le 1M\Omega$	$10\Omega \le R < 1M\Omega$	10Ω≦R<10MΩ	10Ω≦R<10MΩ
(2512) 2W 200V	400V	±200			1Ω≦R<10Ω	1Ω≦R<10Ω		
Operating Temperature Range			е		•	-55℃ ~ +155	\mathbb{C}	•

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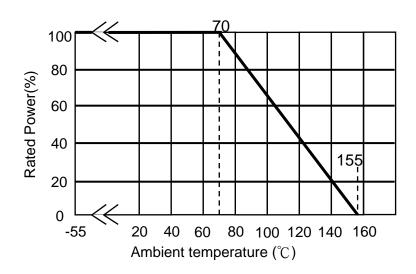


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3.1 Power Derating Curve:

Temperature Range: -55° C ~ $+155^{\circ}$ C

If the ambient temperature exceeds 70 degrees centigrade to 155 degrees centigrade, the power can be modified by the curve as below



3.2 Voltage Rating:

Rated Voltage: DC voltage or AC voltage (rms) based on the rated power. The voltage can be calculated by the following formula. If the calculated value exceeds the Max. voltage specified in the Table 3, the Max. voltage rating is set as the voltage rating.

$$E = \sqrt{R \times P}$$

E= Voltage rating (V)

P= Power rating (W)

R= Nominal resistance(Ω)

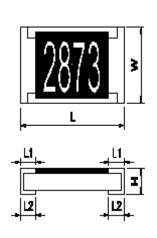
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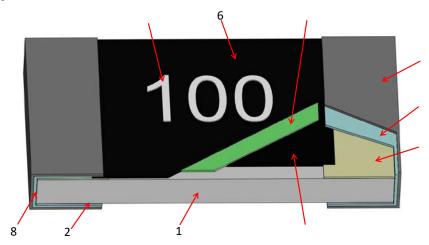
4 Dimensions:

Unit:mm



	Dimension					Offic.ffffff
Type	Size Code	L	W	Н	L1	L2
RAH	0402	1.00±0.10	0.50±0.05	0.30±0.05	0.20±0.10	0.25±0.10
RAH	0603	1.55±0.10	0.80±0.10	0.45±0.10	0.30±0.15	0.30±0.15
RAH	0805	2.00±0.10	1.25±0.10	0.50±0.10	0.35±0.20	0.35±0.20
RAH	1206	3.05±0.10	1.55±0.10	0.50±0.10	0.45±0.20	0.35±0.20
RAH	1210	3.05±0.10	2.55±0.10	0.55±0.10	0.50±0.20	0.50±0.20
RAH	2010	4.95±0.20	2.45±0.10	0.70±0.10	0.65±0.20	0.60±0.20
RAH	2512	6.40±0.20	3.20±0.20	0.70±0.10	0.60±0.20	1.25±0.20

5 Structure Graph:



1	Ceramic substrate	6	2nd Protective coating
2	Bottom inner electrode	7	Marking
3	Top inner electrode	8	Terminal inner electrode
4	Resistive layer	9	Ni plating
5	1st Protective coating	10	Sn plating

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6 Reliability Test:

Reliability	1621.	,
Item	Conditions	Specifications
		Resistors
		0.1%、0.5%、1%:△R%=±1.0% 5%:△R%=±2.0%
	Put the specimens in the High & low temperature test	0.1%、0.5%、1%:△R%=±1.0% 5%:△R%=±2.0%
Short Time Overload		0.1%、0.5%、1%:△R%=±1.0% 5%:△R%=±2.0%
	Solder the specimens on the test PCB and put them into	0.1%、0.5%、1%:△R%=±2.0% 5%:△R%=±3.0%
Operational Life	Solder the specimens on the test PCB and Put them in	0.1%、0.5%、1%:△R%=±2.0% 5%:△R%=±3.0%
Board Flex (Bending Test)	Solder the specimens on the test PCB and put the PCBA onto the Bending Tester. Add force at the central part of PCB, and the duration of the applied forces shall be	0.1%、0.5%、1%:△R%=±1.0% 5%:△R%=±2.0% No mechanical damage, peel-off of side end or chip crack.

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		Specifications
Item	Conditions	Resistors
Resistance to Soldering Heat	solder pot, then take them out to stabilize for 1 hour or more and measure of its resistance variance rate. Temp of solder pot : 260±5℃ Soldering duration : 10±1sec.	0.1%、0.5%、1%:△R%=±1.0% 5%:△R%=±2.0%
ESD	Experiment evidence AEC-Q200 Put the specimens on the test fixture and two (2)discharges (2KVDC) shall be applied to each PUT, one (1) with a positive polarity and one (1) with a negative polarity. Afterwards, the specimens stabilize for 30min or more and measure of its resistance variance rate. The test is performed with direct contact and regular discharge mode. The resistor and capacitor used on the spearhead is 2000Ω and 150pF respectively. Experiment evidence AEC-Q200	
Solderability	Test method: Test item 1 (solder pot test): Method B Precondition: The specimens are subjected to 155°C dry bake for 4hrs±15min. The specimens are immersed into the flux first, then fully immersed into the solder pot, at a temperature of 235±5°C for 5+0/-0.5 sec. Then rinse with water and observe the soldering coverage under the microscope. Test item 2 (Leaching test): Method D The specimens are immersed into the flux first, then fully immersed into the solder pot, at a temperature of 260±5°C for 30+0/-0.5 sec. Then rinse with water and observe the soldering coverage under the microscope. Experiment evidence AEC-Q200	
Electrical	TCR (ppm/°C) = $\frac{(R2-R1)}{R1(T2-T1)}$ ×10 ⁶ R1: Resistance at room temperature (Ω) R2: Resistance at -55°C or +125°C (Ω) T1: Room temperature (°C) T2: Temperature -55°C or +125°C	Refer to item 3. General specifications

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7 Measurement Point:

Measure from bottom electrodes			Unit : mm
	DIM TYPE	Α	В
A	RAH0402	0.80±0.05	0.24±0.05
	RAH0603	1.35±0.05	0.35±0.05
	RAH0805	1.80±0.05	0.35±0.05
	RAH1206	2.90±0.05	0.35±0.05
Current Terminal	RAH1210	2.90±0.05	0.35±0.05
Voltage Terminal	RAH2010	4.50±0.05	1.15±0.05
	RAH2512	5.90±0.05	1.60±0.05

8 Plating Thickness:

- 8.1 Ni:<u>≥</u>2µm
- 8.2 $Sn(Tin):\geq 3um$ 8.3 Sn(Tin):Matte Sn

9 Rule of package empty quantity:

Empty quantity for each reel is not allowed to exceed 0.1% of the whole quantity, and continuous 2pcs (included) empty are also unallowed.

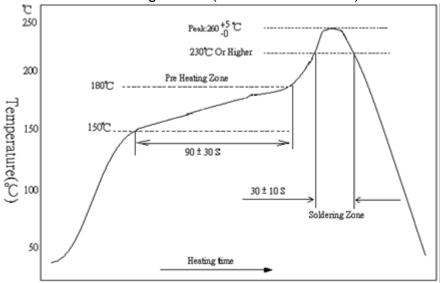
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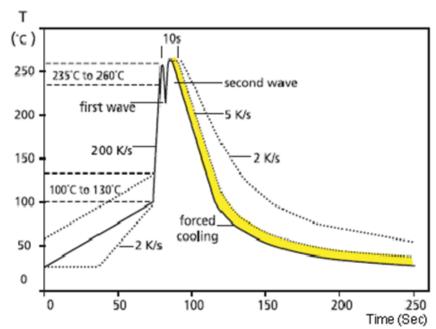
10 Technical application notes: (This is for recommendation, please customer perform adjustment according to actual application)

- 10.1 Recommend Soldering Method:
- 10.1.1Lead Free IR Reflow Soldering Profile (MEET J-STD-020D)



Remark: The peak temperature of soldering heat is 260 +5/-0 $^{\circ}$ C for 10 seconds.

10.1.2Lead Free Double-Wave Soldering Profile. (This applies to 0603 and above size products)



10.1.3Soldering Iron: temperature $350^{\circ}\text{C} \pm 10^{\circ}\text{C}$, dwell time shall be less than 3 sec.

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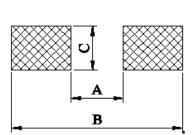


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Unit:mm

10.2 Recommend Land Pattern Design (For Reflow Soldering)

When a component is soldered, the resistance after soldering changes slightly depending on the size of the soldering area and the amount of soldering. When designing a circuit, it is necessary to consider the effect of a decrease or increase in its resistance.



TYPE	Α	В	С
RAH0402	0.5	1.5	0.6
RAH0603	0.8	2.1	0.9
RAH0805	1.2	3.0	1.3
RAH1206	2.2	4.2	1.6
RAH1210	2.2	4.2	2.8
RAH2010	3.5	6.1	2.8
RAH2512	3.8	8.0	3.5

10.3 Automobile Electronic Application:

This specification is for automobile electronic use. RALEC will take no responsibility if any damage, cost or loss occurs when the product has been used in any special circumstances.

- (a) Information , entertainment , navigation , audio control units.
- (b) Comfortable door, window, seat control unit.
- (c) Internal lighting control unit.

10.4 Environment Precautions:

If consumer intends to use our company product in special environment or condition (including but not limited to those mentioned below), then will need to make individual recognition of product features and reliability accordingly.

- (a) Used in high temperature and humidity environment
- (b) Exposed to sea breeze or other corrosive gas, such as Cl2 \ H2S \ NH3 \ SO2 and NO2.
- (c) Used in non-verified liquids including water, oil, chemical and organic solvents.
- (d) Using non-verified resin or other coating material to seal or coat our Company product.
- (e) After soldering, it is necessary to use water-soluble detergents to clean residual solder fluxes, even though no-clean fluxes are recommended.

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10.5 Momentary Overload Precautions:

The product might be out of function when momentary overloaded. Please make sure to avoid momentary overloading while using and preserving.

10.6 Operation and Processing Precautions:

- (a) Avoid damage to the edge of resistor and protective layer caused by mechanical stress.
- (b) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (c) Make sure the power rating is under the limit when using the resistor. When power rating is over the limit, the resister will be overloaded. There might be machinery damage due to the climbing temperature
- (d) If the resister will be exposed under massive impact load (shock wave) in a short period of time, the working environment must be set up well before use.
- (e) Please make evaluation and confirmation when the product is well used in your company and have a through consideration of its fail-safe design to ensure the system safety.

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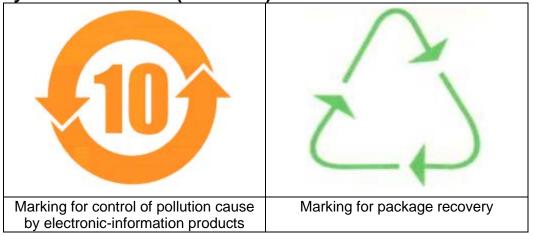


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11 Storage and transportation requirement:

- 11.1 The temperature condition must be controlled at 25±5°C, the R.H. must be controlled at 60±15%. The stock can maintain quality level in two years.
- 11.2 Please avoid the mentioned harsh environment below when storing to ensure product performance and its' weldability. Places exposed to sea breeze or other corrosive gas, such as Cl₂ × H₂S × NH₃ × SO₂ and NO₂.
- 11.3 When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.

12 The carton packaged for electronic-information products is made by the symbol as follows: (For china)



13 Attachments:

13.1 Document Revise Record (QA-QR-027)

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